

# **Preamplifier for IR Remote Control**

#### **Description**

The IC U2535B is a complete IR receiver for data communication. The PIN photodiode converts the transmitted IR telegram into electronic input signals. This is separated by a special input circuit. The characteristics (filter, gain) of the following amplifier are determined by exter-

nal components. The signal detector, consisting of a comparator, an integrator and a Schmitt trigger, forms the input signal to an output pulse that can be interfaced to a microcomputer.

#### **Features**

- Low current requirement (typical 260 μA/ 12 V)
- Carrier frequencies 20 to 100 kHz
- Supply voltages:5 or 7 to 16 V with internal stabilization
- Filter characteristics and gain are specified by few external components
- Demodulator with Schmitt trigger
- Open collector output

#### **Applications**

- Keyless entry
- Remote control
- Wireless data transfer

### **Ordering Information**

Extended Type Number	Package	Remarks
U2535B-FP	SO8	

#### **Block Diagram**

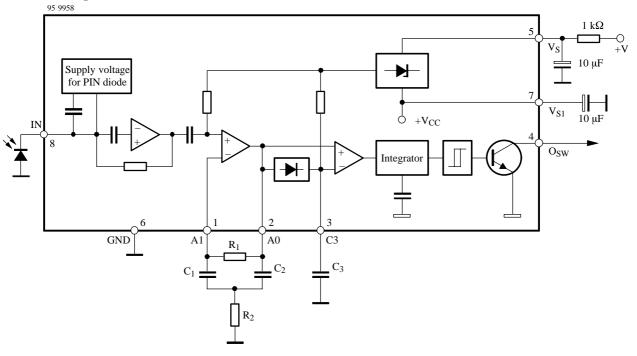


Figure 1. Block diagram

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# **Pin Description**

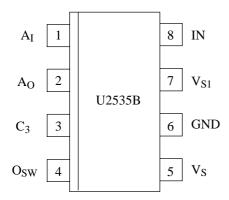


Figure 2. Pinning

Pin	Symbol	Function
1	$A_{\mathrm{I}}$	Inverting input of bandpass amplifier, pin connection for external filter function
2	A <sub>O</sub>	Output of bandpass amplifier
3	C <sub>3</sub>	Capacitor at Pin 3 to reject (suppress) ripple during transmission, also functions as delay time for reference voltage of the comparator
4	O <sub>SW</sub>	Switching output Open collector output which switches with time delay and turns to LOW (transistor switched ON) when the signal is identified at Pin 2.
5	$V_S$	Supply voltage The integrated Z-diode (typically 17 V) protects the circuit against positive voltage spikes
6	GND	Ground
7	$V_{S1}$	Unregulated supply voltage for 5 V operation
8	IN	Input connection for photodiode with regulated bias voltage

# **Absolute Maximum Ratings**

Reference point Pin 6, unless otherwise specified

Parameters		Symbol	Value	Unit
Supply-voltage range	Pin 5	$V_{S}$	-0.3 to +16	V
Supply currents: $tp \le 250 \text{ ms}$	Pin 5 Pin 5	${\rm I_S}\\ {\rm i_S}$	20 150	mA mA
Input voltages	Pin 1 Pin 4 Pin 8	$\begin{matrix} V_{A(I)} \\ V_{0(SW)} \\ V_{IN} \end{matrix}$	-0.3 to 5 -0.3 to 16 -0.3 to 5	V V V
Output currents	Pins 2 and 4	$I_0$	±5	mA
Junction temperature		Tj	125	°C
Storage-temperature range		T <sub>stg</sub>	-40 to +125	°C
Ambient-temperature range		T <sub>amb</sub>	-40 to +105	°C

## **Thermal Resistance**

Parameters	Symbol	Value	Unit
Junction ambient	R <sub>thJA</sub>	180	K/W

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### **Electrical Characteristics**

T<sub>amb</sub> = 25°C, reference point Pin 6, test circuit, unless otherwise specified

Parameters	Test Conditions / Pins	Symbol	Min.	Тур.	Max.	Unit
Supply currents	$egin{array}{lll} V_{S1} = 5 & V, \ I_{IN} = 0, & \ Pin \ 7 \\ V_{S} = 12 & V, \ I_{IN} = 0, & \ Pin \ 5 \\ \end{array}$	$egin{array}{c} I_{S1} \ I_{S} \end{array}$	140 200		200 320	μΑ μΑ
Internal stabilization	$V_S = 12 \text{ V}, I_{IN} = 0, \text{ Pin 7}$	$V_{S1}$	4.9		5.4	V
Maximum input current	$V_{S1} = 5 \text{ V}, V_{IN} = 0, \text{ Pin } 8$	$-I_{IN}$	0.8		1.2	mA
Low-level voltage	$V_{S1} = 5 \text{ V}, I_{OL} = 0.5 \text{ mA}$ Pin 4	$V_{OL}$			0.2	V
Leakage current	$V_{S1} = 5 \text{ V}, V_0 = 12 \text{ V}, \text{ Pin 4}$	$I_{OH}$			1	μΑ
Input stage, amplifier	Input stage, amplifier					
Cut-off frequency		$ m f_L \ f_H$	100		15	kHz kHz
Gain	$\label{eq:vi} \begin{aligned} v_i &= 2 \ mV_{rms}, \\ f &= 40 \ kHz \\ f &= 100 \ kHz \end{aligned}$	$\begin{array}{c} G_v \\ G_v \end{array}$	47 46	50 49		dB dB
Detector						
Threshold voltage	$t_d \le 200 \ \mu s, \ f = 40 \ kHz,$ Pin 2	$V_{A0}$		150		mV <sub>rms</sub>
Delay time	$f = 40 \text{ kHz}, V_{A0} = 1 V_{rms}$ see figure 4	t <sub>d</sub>	50	90		μs
Storage time		$t_{s}$	100	_	150	μs

## **Test Circuit**

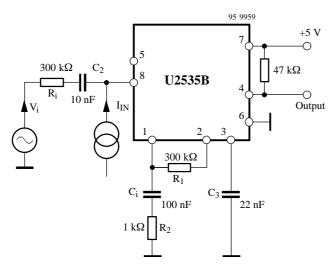


Figure 3. Test circuit

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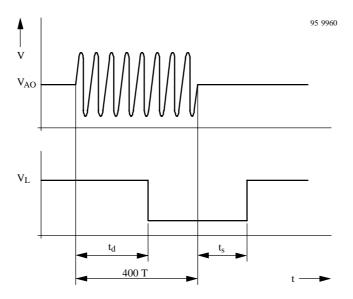


Figure 4. Waveforms for  $t_{d}$  and  $t_{s}$  measurement  $% \left( t_{d}\right) =\left( t_{d}\right) \left( t_{d}\right)$ 

# **Application Circuit**

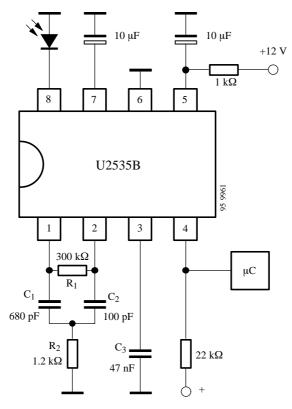


Figure 5. Application circuit

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### **Bandpass Filter Design**

#### **Center frequency**

$$f_{o} = \frac{1}{2\pi~\sqrt{R_{1}\times C_{1}\times R_{2}\times C_{2}}}$$

$$\text{GAIN} \approx \frac{R_1 \times C_1}{R_2 (C_1 + C_2)} \qquad \qquad \begin{array}{c} R_1 >> R_2 \\ C_1 \geqq C_2 \end{array}$$

$$Bandwidth \approx \frac{C_1 + C_2}{2\pi \times R_1 \times C_1 \times C_2} \qquad BW << f_O$$

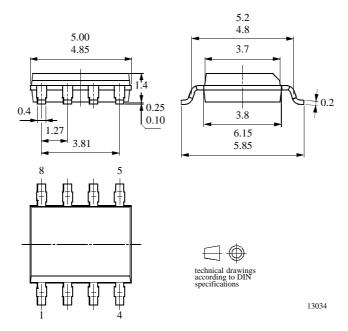
Note:  $R_1$  should be about 300  $k\Omega$ .

Results can be influenced by feedback (Pin  $2 \rightarrow Pin 8$ )

## **Package Information**

Package SO8

Dimensions in mm



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#### **Ozone Depleting Substances Policy Statement**

It is the policy of Atmel Germany GmbH to

- 1. Meet all present and future national and international statutory requirements.
- Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**Atmel Germany GmbH** has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

**Atmel Germany GmbH** can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

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Data sheets can also be retrieved from the Internet: http://www.atmel-wm.com

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